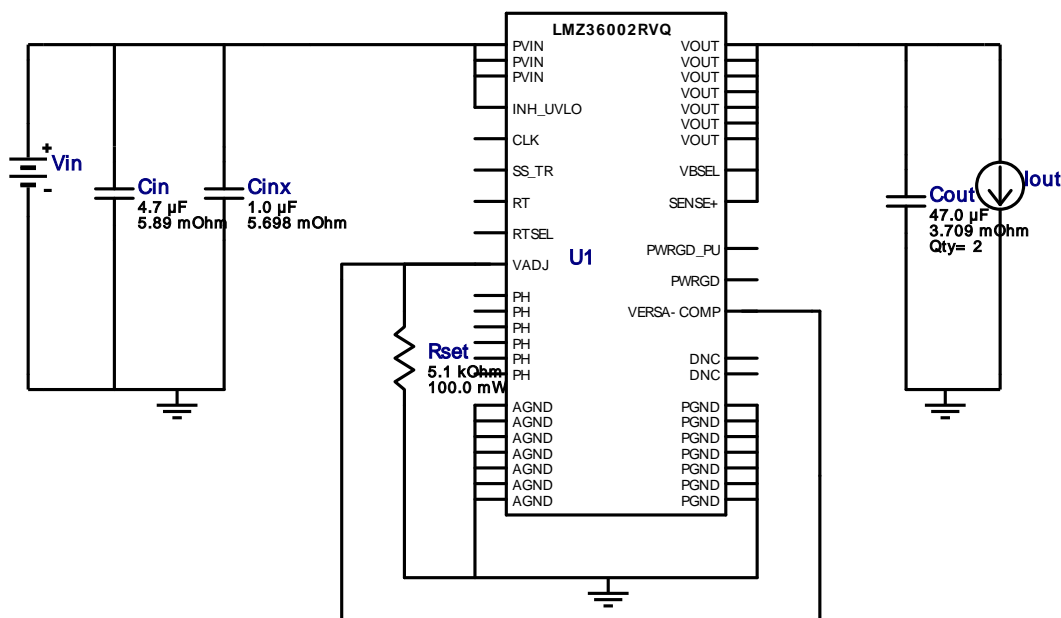
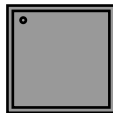


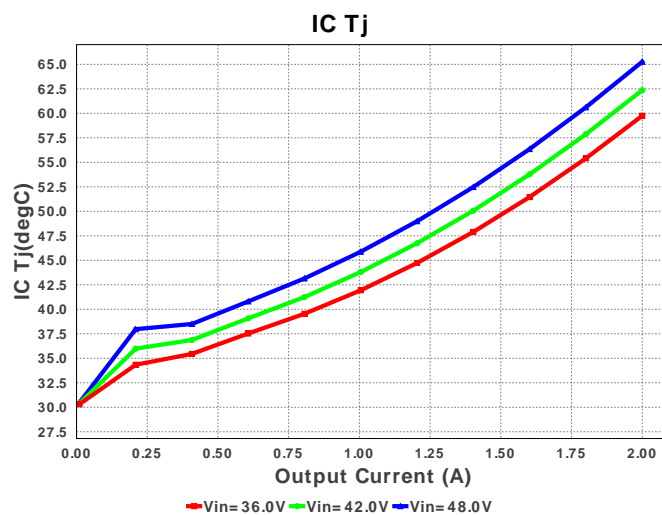
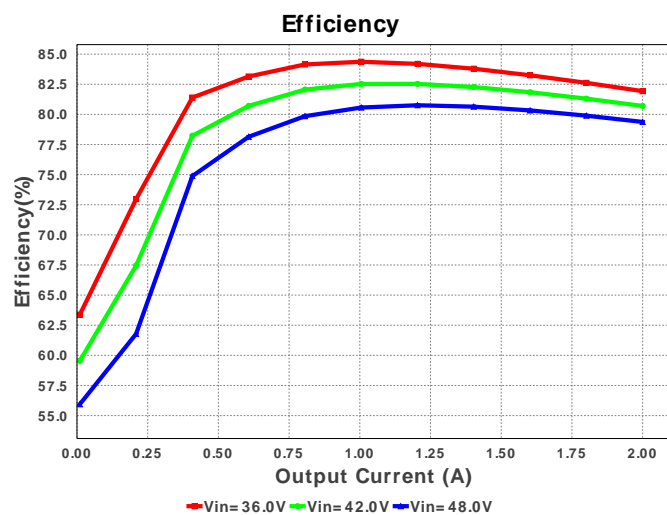
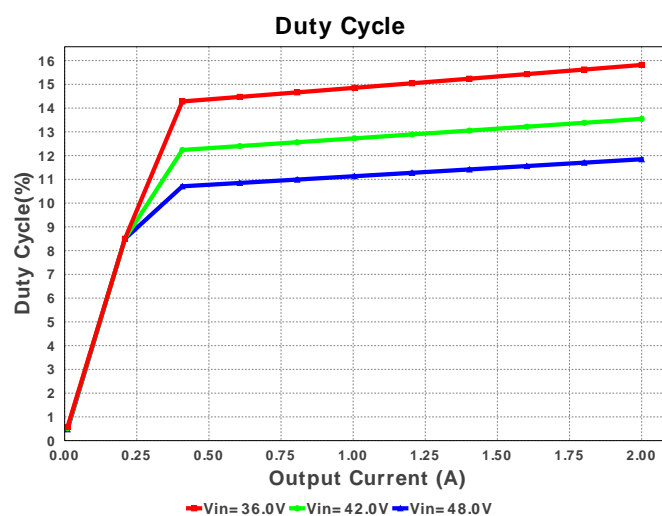
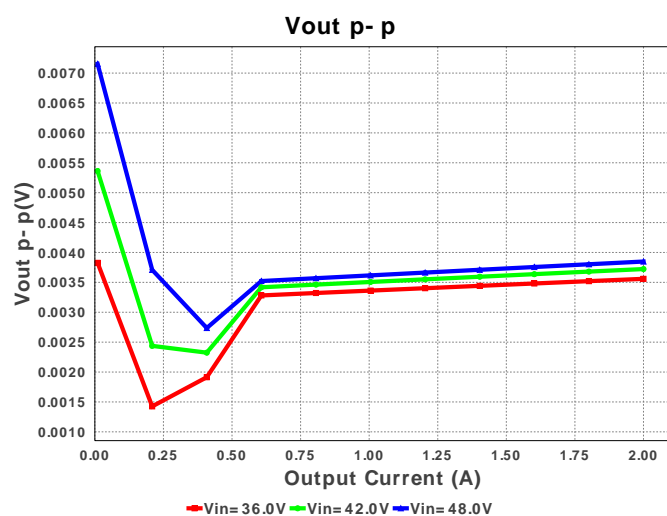
**Vout = 5.0V
Iout = 2.0A**


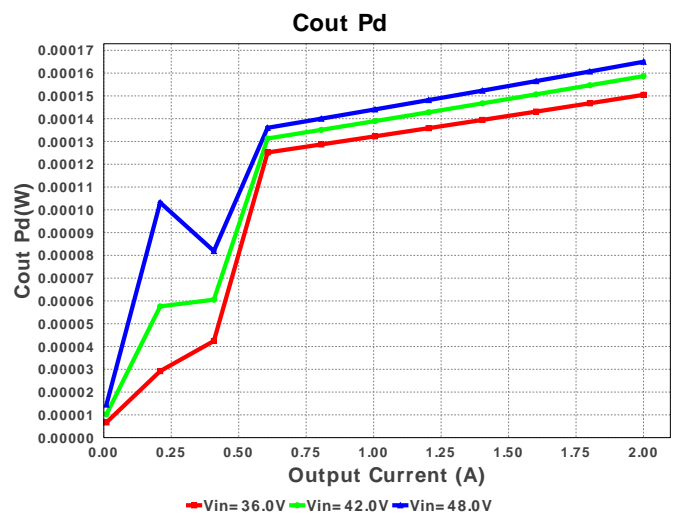
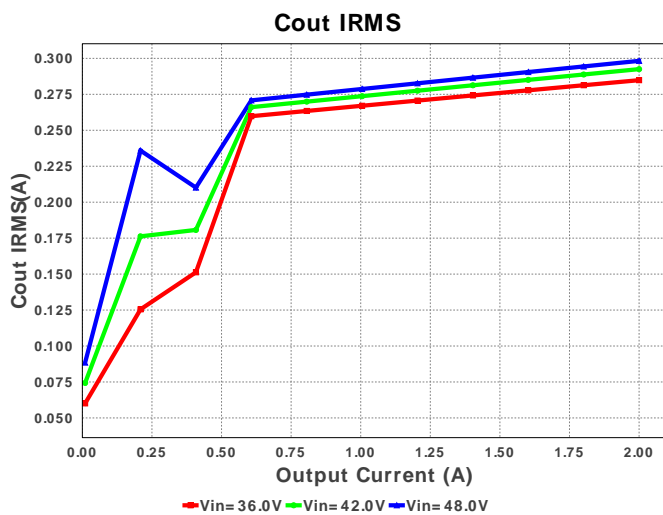
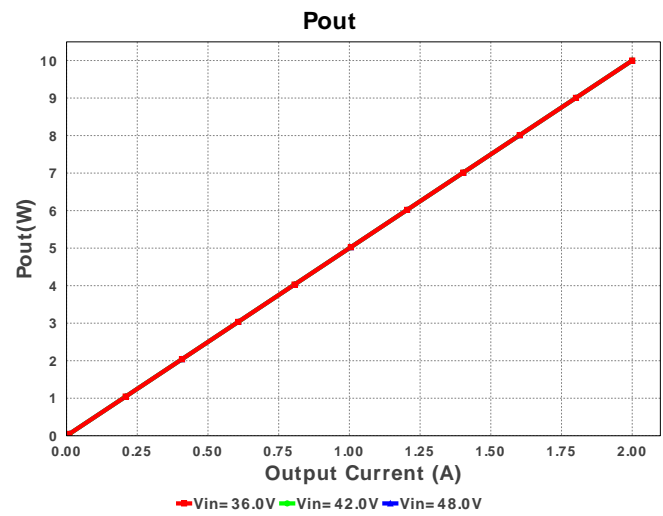
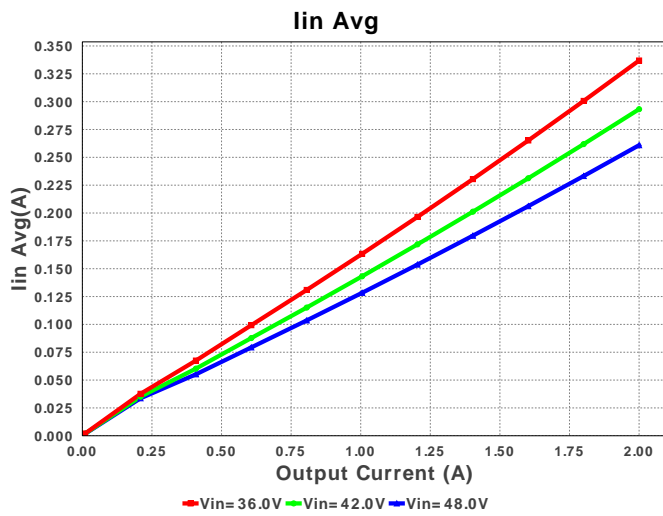
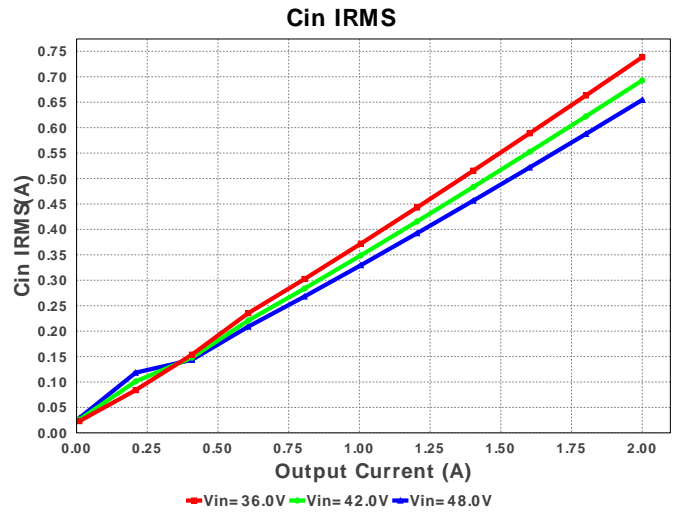
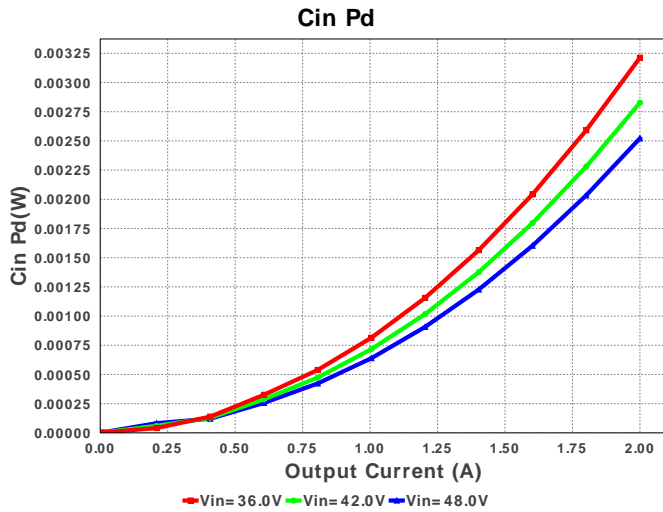
1. The input capacitor included in the BOM only contains a small filter capacitor that should be placed near the IC. Depending on where the power supply is laid out in the system additional bulk capacitance may need to be added to filter the line ripple.
2. If there is no VinTyp specified, WEBENCH will use the VinMax value. To change the VinTyp value, click on the "Change Design Inputs" button under the Optimization Tuning knob. In some applications, while the design requires the input voltage to be a wide range, for a majority of the time, it is operating at a much lower voltage than the maximum input voltage. Sizing the inductor based on the maximum input voltage may yield an inductance much larger than typically needed, causing a larger footprint for the overall design. At the same time, components such as the input capacitor must be rated based on the maximum input voltage. WEBENCH now supports the use of this additional input voltage specification.

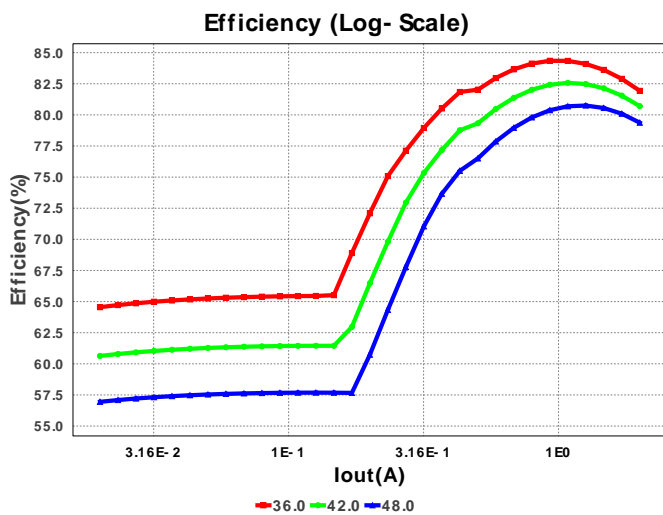
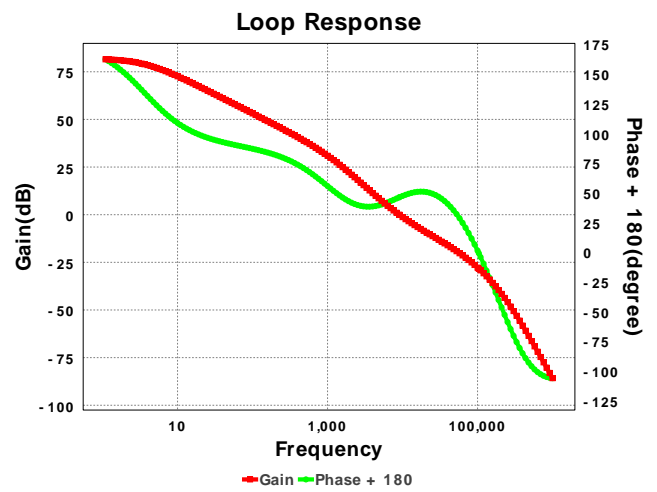
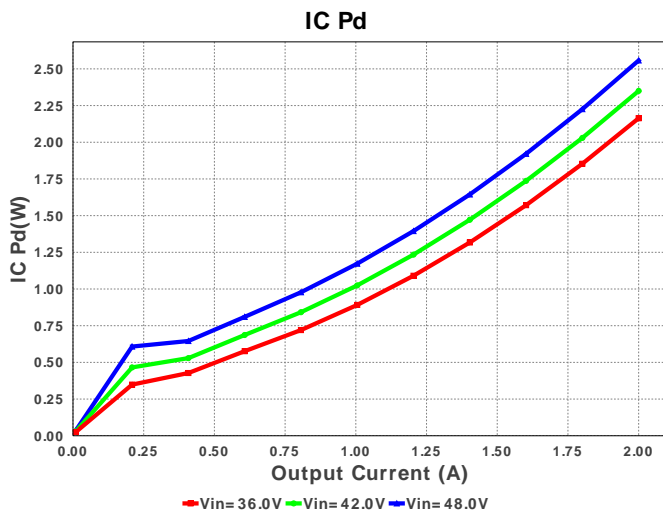
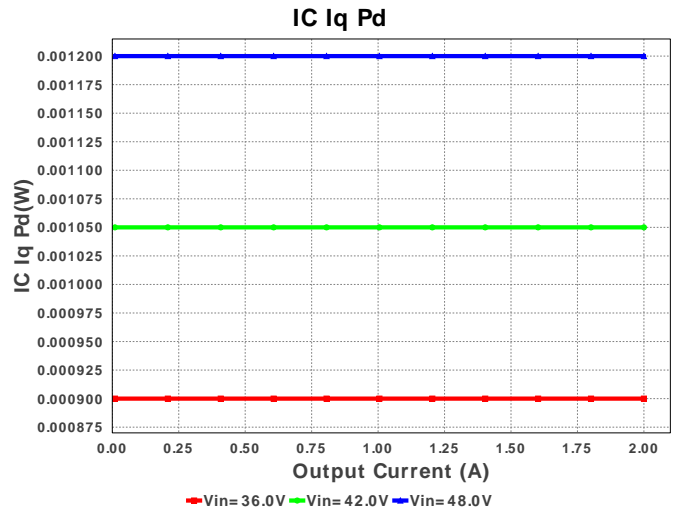
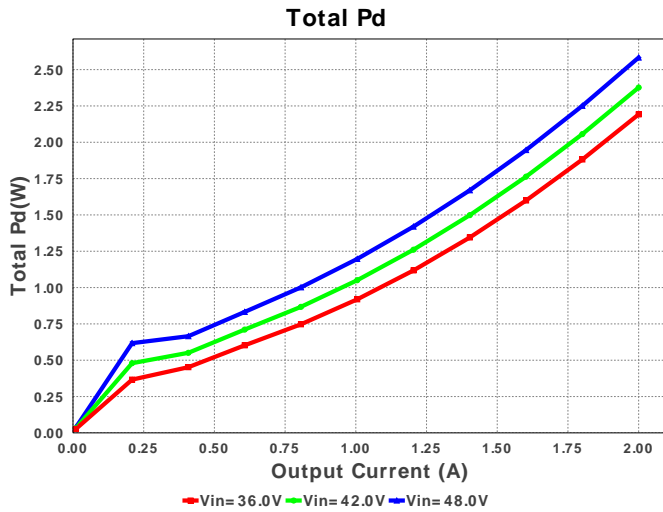
Electrical BOM

#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
1.	Cin	TDK	C3225X7S2A475M200AB Series= X7S	Cap= 4.7 uF ESR= 5.89 mOhm VDC= 100.0 V IRMS= 6.7739 A	1	\$0.42	1210 15 mm ²
2.	Cinx	TDK	C3216X5R2A105K Series= X5R	Cap= 1.0 uF ESR= 5.698 mOhm VDC= 100.0 V IRMS= 0.0 A	1	\$0.07	1206 11 mm ²
3.	Cout	MuRata	GRM31CR61A476KE15L Series= X5R	Cap= 47.0 uF ESR= 3.709 mOhm VDC= 10.0 V IRMS= 4.2862 A	2	\$0.15	1206_190 11 mm ²
4.	Rset	Yageo America	RC0603FR-075K1L Series= ?	Res= 5.1 kOhm Power= 100.0 mW Tolerance= 1.0%	1	\$0.01	0603 5 mm ²

#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
5.	U1	Texas Instruments	LMZ36002RVQR	Switcher	1	\$7.95	 RVQ0043A 144 mm ²







Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	654.407 mA	Current	Input capacitor RMS ripple current
2.	Cout IRMS	298.264 mA	Current	Output capacitor RMS ripple current
3.	Iin Avg	260.89 mA	Current	Average input current
4.	BOM Count	6	General	Total Design BOM count
5.	FootPrint	196.0 mm ²	General	Total Foot Print Area of BOM components
6.	Frequency	500.0 kHz	General	Switching frequency
7.	Pout	10.0 W	General	Total output power
8.	Total BOM	\$8.75	General	Total BOM Cost
9.	Low Freq Gain	81.531 dB	Op_Point	Gain at 10Hz
10.	Vout OP	5.0 V	Op_Point	Operational Output Voltage
11.	Cross Freq	9.474 kHz	Op_point	Bode plot crossover frequency

#	Name	Value	Category	Description
12.	Duty Cycle	11.846 %	Op_point	Duty cycle
13.	Efficiency	79.373 %	Op_point	Steady state efficiency
14.	Gain Marg	-24.039 dB	Op_point	Bode Plot Gain Margin
15.	IC Tj	65.266 degC	Op_point	IC junction temperature
16.	ICThetaJA	14.0 degC/W	Op_point	IC junction-to-ambient thermal resistance
17.	IOUT_OP	2.0 A	Op_point	Iout operating point
18.	Phase Marg	64.509 deg	Op_point	Bode Plot Phase Margin
19.	VIN_OP	48.0 V	Op_point	Vin operating point
20.	Vout p-p	3.848 mV	Op_point	Peak-to-peak output ripple voltage
21.	Cin Pd	2.522 mW	Power	Input capacitor power dissipation
22.	Cout Pd	164.979 µW	Power	Output capacitor power dissipation
23.	IC Iq Pd	1.2 mW	Power	IC Iq Pd
24.	IC Pd	2.558 W	Power	IC power dissipation
25.	Total Pd	2.583 W	Power	Total Power Dissipation
26.	Vout Tolerance	200.0 m%		Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable

Design Inputs

#	Name	Value	Description
1.	Iout	2.0	Maximum Output Current
2.	VinMax	48.0	Maximum input voltage
3.	VinMin	36.0	Minimum input voltage
4.	Vout	5.0	Output Voltage
5.	base_pn	LMZ36002	Base Product Number
6.	source	DC	Input Source Type
7.	Ta	30.0	Ambient temperature

Design Assistance

1. **LMZ36002** Product Folder : <http://www.ti.com/product/LMZ36002> : contains the data sheet and other resources.

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